

# 2-Bit Dual-Supply Level Translator

## NL3V2T244, NL3V2T240

The NL3V2T244 / NL3V2T240 are 2-bit configurable dual-supply level translators with 3-state outputs. The A- and B- ports are designed to track two different power supply rails,  $V_{CCA}$  and  $V_{CCB}$  respectively. Both supply rails are configurable from 0.9 V to 3.6 V allowing universal voltage level translation between the A to B ports.

The NL3V2T244 is a 2-bit level translator that allows non-inverting translations from A to B ports. The NL3V4T240 is a 2-bit level translator that allows inverting translations from A to B ports.

The output enable pin ( $\overline{OE}$ ), when High, disables all the output ports by putting them in 3-state. The  $\overline{OE}$  pin is designed to track  $V_{CCA}$ .

### Features

- Wide  $V_{CCA}$  and  $V_{CCB}$  Operating Range: 0.9 V to 3.6 V
- Balanced Output Drive:  $\pm 24$  mA @ 3.0 V
- High-Speed w/ Balanced Propagation Delay: 2.8 ns max at 3.0 to 3.6 V
- Input/Output Pins OVT to 3.6 V
- Non-preferential  $V_{CC}$  Sequencing
- Outputs at 3-State until Active  $V_{CC}$  is Reached
- Partial Power-Off Protection
- Outputs Switch to 3-State with either  $V_{CC}$  at GND
- Typical Max Data Rates:
  - 380 Mbps ( $\geq 1.8$ -V to 3.3-V Translation)
  - 200 Mbps ( $\geq 1.1$ -V to [1.8-V, 2.5-V, 3.3-V] Translation)
  - 150 Mbps ( $\geq 1.1$ -V to 1.5-V Translation)
  - 100 Mbps ( $\geq 1.1$ -V to 1.2-V Translation)
- Small Pb-Free Packaging: SOIC-8, Micro8, UDFN8
- -Q Suffix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable\*
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

### Typical Applications

- Mobile Phones, PDAs, Other Portable Devices
- Automotive
- Industrial

### MARKING DIAGRAMS



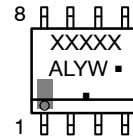
**UDFN8**  
**MU SUFFIX**  
**CASE 517AJ**



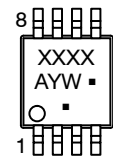
XX = Specific Device Code  
M = Date Code  
▪ = Pb-Free Package



**SO-8**  
**D SUFFIX**  
**CASE 751**



**Micro8**  
**DM SUFFIX**  
**CASE 846A**



A = Assembly Location  
L = Wafer Lot  
Y = Year  
W = Work Week  
▪ = Pb-Free Package

### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 7 of this data sheet.

## NL3V2T244, NL3V2T240

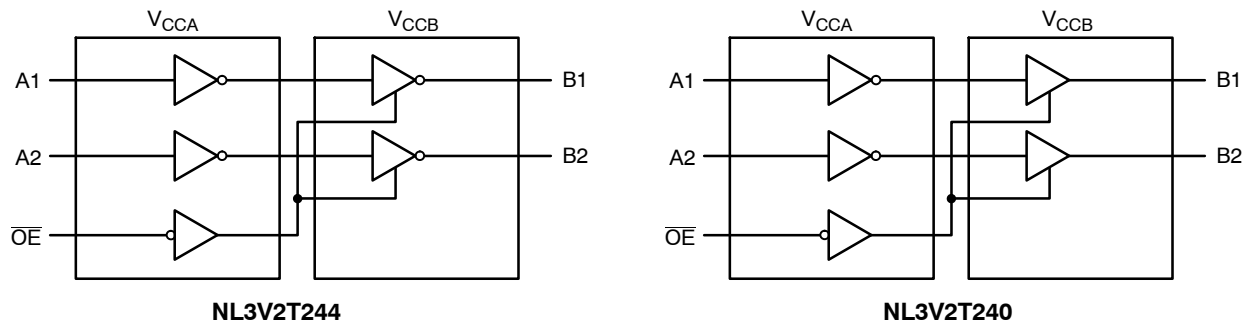


Figure 1. Logic Diagrams

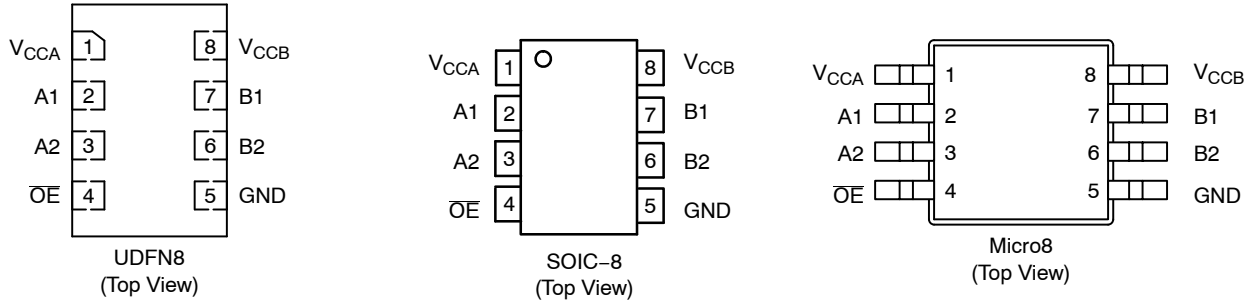


Figure 2. Pin Assignments (Top View)

### FUNCTION TABLE

INPUTS		NL3V2T244 OUTPUT	NL3V2T240 OUTPUT
$\overline{OE}$	$A_n$	$B_n$	$B_n$
L	L	L	H
L	H	H	L
H	X	3-State	3-State

### PIN NAMES

PINS	DESCRIPTION
$V_{CCA}$	A Port DC Supply
$V_{CCB}$	B Port DC Supply
GND	Ground
$\overline{OE}$	Output Enable
A1, A2	Input Ports
B1, B2	Output Ports

### Application Recommendations

During power-up and power-down, it is recommended that the  $\overline{OE}$  pin be connected to  $V_{CC}$  through pull-up resistors to ensure high impedance at the I/O ports.

# NL3V2T244, NL3V2T240

## MAXIMUM RATINGS

Symbol	Rating	Value	Condition	Unit	
$V_{CCA}, V_{CCB}$	DC Supply Voltage	-0.5 to +4.3		V	
$V_I$	DC Input Voltage	-0.5 to +4.3		V	
$V_O$	DC Output Voltage (Power Down Mode)	-0.5 to +4.3	$V_{CCA} = V_{CCB} = 0$	V	
	(3-State Mode)	-0.5 to +4.3			
	(Active Mode)	-0.5 to $V_{CCB}+0.5$			
$I_{IK}$	DC Input Diode Current	-50	$V_I < \text{GND}$	mA	
$I_{OK}$	DC Output Diode Current	-50	$V_O < \text{GND}$	mA	
$I_O$	DC Output Source/Sink Current	$\pm 50$		mA	
$I_{CC}$	DC Supply Current Per Supply Pin	$\pm 100$		mA	
$I_{GND}$	DC Ground Current per Ground Pin	$\pm 100$		mA	
$T_{STG}$	Storage Temperature Range	-65 to +150		°C	
$\theta_{JA}$	Thermal Resistance (Note 1)	SOIC-8	134	°C/W	
		Micro8			167
		UDFN8			231
$P_D$	Power Dissipation in Still Air	SOIC-8	935	mW	
		Micro8			748
		UDFN8			541
MSL	Moisture Sensitivity Level		Level 1	-	
$F_R$	Flammability Rating	Oxygen Index: 28 to 34	UL 94 V-0 @ 0.125 in	-	
$V_{ESD}$	ESD Withstand Voltage (Note 2)	Human Body Model	2	kV	
		Charged Device Model	1		
$I_{LATCHUP}$	Latchup Performance (Note 3)		$\pm 100$	mA	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Measured with minimum pad spacing on an FR4 board, using 76mm-by-114mm, 2-ounce copper trace no air flow per JESD51-7.
2. HBM tested to ANSI/ESDA/JEDEC JS-001-2017. CDM tested to EIA/JESD22-C101-A. JEDEC recommends that ESD qualification to EIA/JESD22-A115A (Machine Model) be discontinued per JEDEC/JEP172A.
3. Tested to EIA/JESD78 Class II.

## RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Max	Unit
$V_{CCA}, V_{CCB}$	Positive DC Supply Voltage	0.9	3.6	V
$V_I$	Input Voltage	GND	3.6	V
$V_O$	Output Voltage (Power Down Mode)	GND	3.6	V
	(3-State Mode)	GND	3.6	
	(Active Mode)	GND	$V_{CCB}$	
$T_A$	Operating Temperature Range	-40	+125	°C
$\Delta t / \Delta V$	Input Transition Rise or Rate	0	5	nS/V

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

# NL3V2T244, NL3V2T240

## DC ELECTRICAL CHARACTERISTICS – INPUT VOLTAGES

Symbol	Parameter	Test Conditions	Port	V <sub>CCA</sub> (V)	V <sub>CCB</sub> (V)	-40°C to +85°C			-40°C to +125°C		Unit
						Min	Typ (Note 4)	Max	Min	Max	
V <sub>IH</sub>	Input HIGH Voltage		$\overline{OE}$ , A	2.7 – 3.6	0.9 – 3.6	2.0	–	–	2.0	–	V
				2.3 – 2.7		1.6	–	–	1.6	–	
				1.65–1.95		0.65 V <sub>CCA</sub>	–	–	0.65 V <sub>CCA</sub>	–	
				1.1 – 1.6		0.7 V <sub>CCA</sub>	–	–	0.7 V <sub>CCA</sub>	–	
				0.9		–	0.9 V <sub>CCA</sub>	–	–	–	
V <sub>IL</sub>	Input LOW Voltage		$\overline{OE}$ , A	2.7 – 3.6	0.9 – 3.6	–	–	0.8	–	0.8	V
				2.3 – 2.7		–	–	0.7	–	0.7	
				1.65–1.95		–	–	0.35 V <sub>CCA</sub>	–	0.35 V <sub>CCA</sub>	
				1.1 – 1.6		–	–	0.3 V <sub>CCA</sub>	–	0.3 V <sub>CCA</sub>	
				0.9		–	0.1 V <sub>CCA</sub>	–	–	–	

4. All typical values are at T<sub>A</sub> = 25°C.

## DC ELECTRICAL CHARACTERISTICS – OUTPUT VOLTAGES

Symbol	Parameter	Test Conditions	V <sub>CCA</sub> (V)	V <sub>CCB</sub> (V)	-40°C to +85°C			-40°C to +125°C		Unit
					Min	Typ (Note 4)	Max	Min	Max	
V <sub>OH</sub>	Output HIGH Voltage	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> :								V
		I <sub>OH</sub> = -100 μA	0.9	0.9	–	V <sub>CCB</sub> - 0.1	–	–	–	
			1.1 – 3.6	1.1 – 3.6	V <sub>CCB</sub> - 0.1	–	–	V <sub>CCB</sub> - 0.1	–	
		I <sub>OH</sub> = -3 mA	1.1	1.1	0.85	–	–	0.85	–	
		I <sub>OH</sub> = -6 mA	1.4	1.4	1.05	–	–	1.05	–	
		I <sub>OH</sub> = -8 mA	1.65	1.65	1.2	–	–	1.2	–	
			2.3	2.3	1.8	–	–	1.8	–	
		I <sub>OH</sub> = -12 mA	2.7	2.7	2.2	–	–	2.2	–	
			2.3	2.3	1.7	–	–	1.7	–	
I <sub>OH</sub> = -18 mA	3.0	3.0	2.4	–	–	2.4	–			
I <sub>OH</sub> = -24 mA	3.0	3.0	2.2	–	–	2.2	–			
V <sub>OL</sub>	Output LOW Voltage	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> :								V
		I <sub>OL</sub> = 100 μA	0.9	0.9	–	0.1	–	–	–	
			1.1 – 3.6	1.1 – 3.6	–	–	0.1	–	0.1	
		I <sub>OL</sub> = 3 mA	1.1	1.1	–	–	0.25	–	0.25	
		I <sub>OL</sub> = 6 mA	1.4	1.4	–	–	0.35	–	0.35	
		I <sub>OL</sub> = 8 mA	1.65	1.65	–	–	0.3	–	0.3	
			2.3	2.3	–	–	0.4	–	0.4	
		I <sub>OL</sub> = 12 mA	2.7	2.7	–	–	0.4	–	0.4	
			2.3	2.3	–	–	0.4	–	0.4	
I <sub>OL</sub> = 18 mA	3.0	3.0	–	–	0.4	–	0.4			
	3.0	3.0	–	–	0.4	–	0.4			
I <sub>OL</sub> = 24 mA	3.0	3.0	–	–	0.55	–	0.55			

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## DC ELECTRICAL CHARACTERISTICS – LEAKAGE AND SUPPLY CURRENTS

Symbol	Parameter	Test Conditions	V <sub>CCA</sub> (V)	V <sub>CCB</sub> (V)	-40°C to +85°C		-40°C to +125°C		Unit	
					Min	Max	Min	Max		
I <sub>I</sub>	Input Leakage Current	V <sub>I</sub> = 3.6 V or GND	0.9 – 3.6	0.9 – 3.6	–	±1.0	–	±5.0	μA	
I <sub>OZ</sub>	3-State Output Leakage	$\overline{OE} = V_{IH}$ ; V <sub>O</sub> = GND to 3.6 V	3.6	3.6	–	±1.0	–	±5.0	μA	
I <sub>OFF</sub>	Power-Off Leakage Current	V <sub>I</sub> or V <sub>O</sub> = 0 to 3.6 V	A	0	0.9 – 3.6	–	±1.0	–	±5.0	μA
			B	0.9 – 3.6	0	–	±1.0	–	±5.0	
I <sub>CCA</sub>	Quiescent Supply Current	V <sub>I</sub> = V <sub>CCA</sub> or GND; I <sub>O</sub> = 0	0.9 – 3.6	0.9 – 3.6	–	5.0	–	10	μA	
			0	0.9 – 3.6	–	–1.0	–	–5.0		
			0.9 – 3.6	0	–	5.0	–	10		
I <sub>CCB</sub>	Quiescent Supply Current	V <sub>I</sub> = V <sub>CCB</sub> or GND; I <sub>O</sub> = 0	0.9 – 3.6	0.9 – 3.6	–	5.0	–	10	μA	
			0	0.9 – 3.6	–	5.0	–	10		
			0.9 – 3.6	0	–	–1.0	–	–5.0		

NOTE: Connect ground before applying supply voltage V<sub>CCA</sub> or V<sub>CCB</sub>. This device is designed with the feature that the power-up sequence of V<sub>CCA</sub> and V<sub>CCB</sub> will not damage the IC.

## AC ELECTRICAL CHARACTERISTICS (Notes 5 and 6)

Symbol	Parameter	V <sub>CCA</sub> (V)	T <sub>A</sub> = -40°C to +85°C					T <sub>A</sub> = -40°C to +125°C					Unit
			V <sub>CCB</sub> (V)					V <sub>CCB</sub> (V)					
			3.3	2.5	1.8	1.5	1.2	3.3	2.5	1.8	1.5	1.2	
t <sub>PLH</sub> , t <sub>PHL</sub>	Propagation Delay, A to B	3.3	2.9	3.3	4.5	5.6	9.3	3.3	3.8	5.0	6.2	9.5	nS
		2.5	3.6	3.7	4.6	5.7	9.4	4.0	4.0	5.1	6.3	9.6	
		1.8	3.9	4.0	4.9	6.0	9.6	4.3	4.3	5.4	6.6	9.8	
		1.5	4.2	4.3	5.2	6.3	9.8	4.7	4.7	5.8	7.0	10.0	
		1.2	5.1	5.2	6.2	7.1	11.0	5.7	5.8	6.9	7.9	11.2	
t <sub>pZH</sub> , t <sub>pZL</sub>	Output Enable, OE to B	3.3	3.8	4.7	6.8	8.7	11.6	4.2	5.2	7.5	9.6	12.4	nS
		2.5	4.0	4.8	7.0	8.8	11.6	4.4	5.3	7.7	9.7	12.4	
		1.8	4.6	5.3	7.4	9.2	11.9	5.1	5.9	8.2	10.2	12.9	
		1.5	5.6	5.8	7.7	9.6	12.5	6.2	6.4	8.5	10.6	13.3	
		1.2	7.7	7.9	8.9	10.0	13.9	8.5	8.7	9.8	11.0	14.7	
t <sub>pHZ</sub> , t <sub>pLZ</sub>	Output Disable, OE to B	3.3	6.2	6.4	8.1	9.3	10.2	6.9	7.1	9.0	10.3	11.3	nS
		2.5	5.2	6.2	8.2	8.8	10.4	5.8	6.9	9.1	10.4	11.5	
		1.8	6.9	6.9	8.7	9.9	10.9	7.6	7.6	9.6	10.9	12.0	
		1.5	7.6	7.4	9.1	10.3	11.3	8.2	8.4	10.1	11.4	12.5	
		1.2	8.1	8.1	9.5	9.6	12.4	9.0	10.1	10.5	10.6	13.7	

5. Propagation delays defined per Figure 3.

6. These parameters are guaranteed by characterization and are not production tested.

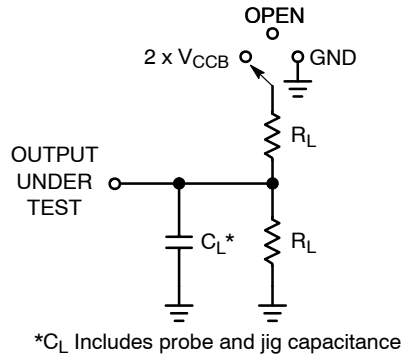
## CAPACITANCE

Symbol	Parameter	Test Conditions	Typ (Note 4)	Unit
C <sub>IN</sub>	Control Pin Input Capacitance	V <sub>CCA</sub> = V <sub>CCB</sub> = 3.3 V, V <sub>I</sub> = 0 V or V <sub>CCA</sub>	2.5	pF
C <sub>I/O</sub>	I/O Pin Input Capacitance	V <sub>CCA</sub> = V <sub>CCB</sub> = 3.3 V, V <sub>I</sub> = 0 V or V <sub>CCA</sub>	5.0	pF
C <sub>PD</sub> (Note 7)	Power Dissipation Capacitance	V <sub>CCA</sub> = V <sub>CCB</sub> = 3.3 V, V <sub>I</sub> = 0 V or V <sub>CCA</sub> , f = 10 MHz	12	pF

7. C<sub>PD</sub> is defined as the value of the IC's equivalent capacitance from which the operating current can be calculated from:

$$I_{CC(\text{operating})} \cong C_{PD} \times V_{CC} \times f_{IN} \times N_{SW} \text{ where } I_{CC} = I_{CCA} + I_{CCB} \text{ and } N_{SW} = \text{total number of outputs switching.}$$

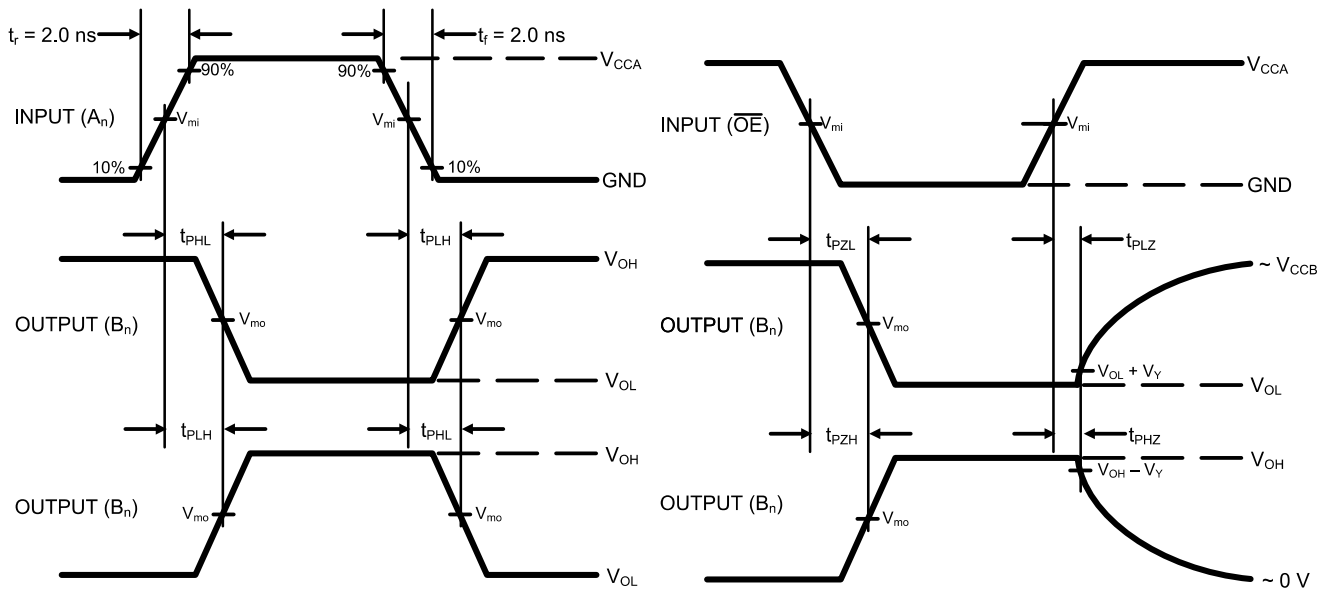
# NL3V2T244, NL3V2T240



**Figure 3. AC Test Circuit**

Test	Switch	C <sub>L</sub>	R <sub>L</sub>
t <sub>PLH</sub> , t <sub>PZH</sub>	OPEN	15 pF	2 kΩ
t <sub>PLZ</sub> , t <sub>PZL</sub>	2 x V <sub>CCB</sub>		
t <sub>PHZ</sub> , t <sub>PZH</sub>	GND		

C<sub>L</sub> includes probe and jig capacitance  
Pulse generator Z<sub>O</sub> = 50 Ω  
Input f = 1.0 MHz; t<sub>W</sub> = 500 ns



**Figure 4. AC Waveforms**

Symbol	V <sub>CC</sub>				
	3.0 V – 3.6 V	2.3 V – 2.7 V	1.65 V – 1.95 V	1.4 V – 1.6 V	1.1 V – 1.3 V
V <sub>mi</sub>	V <sub>CCA</sub> /2	V <sub>CCA</sub> /2	V <sub>CCA</sub> /2	V <sub>CCA</sub> /2	V <sub>CCA</sub> /2
V <sub>mo</sub>	V <sub>CCB</sub> /2	V <sub>CCB</sub> /2	V <sub>CCB</sub> /2	V <sub>CCB</sub> /2	V <sub>CCB</sub> /2
V <sub>Y</sub>	0.3 V	0.15 V	0.15 V	0.1 V	0.1 V

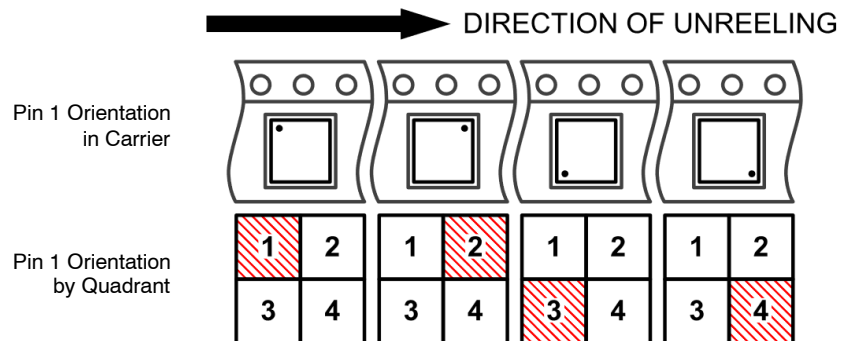
# NL3V2T244, NL3V2T240

## ORDERING INFORMATION

Device	Marking	Package	Pin 1 Quadrant	Shipping <sup>†</sup>
NL3V2T244MUTAG	AD	UDFN8	1	3000 Units / Tape & Reel
NL3V2T244DR2G (Contact <b>onsemi</b> sales)	TBD	SOIC-8	1	2500 Units / Tape & Reel
NL3V2T244DMR2G	T244	Micro8	1	4000 Units / Tape & Reel
NL3V2T244DMR2G-Q*	T244	Micro8	1	4000 Units / Tape & Reel
NL3V2T240MUTAG	AK	UDFN8	1	3000 Units / Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

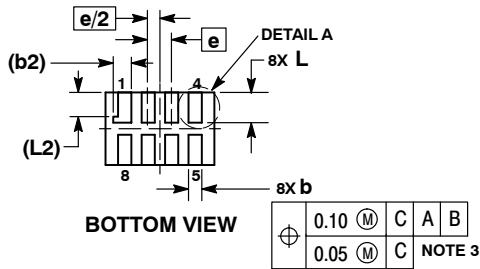
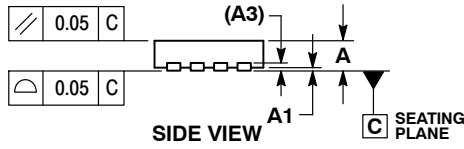
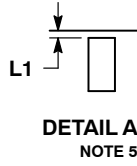
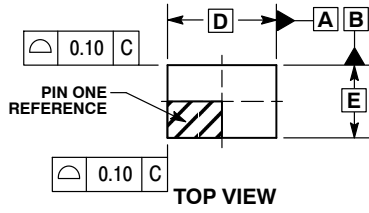
### Pin 1 Orientation in Tape and Reel



# NL3V2T244, NL3V2T240

## PACKAGE DIMENSIONS

UDFN8 1.8 x 1.2, 0.4P  
CASE 517AJ  
ISSUE O

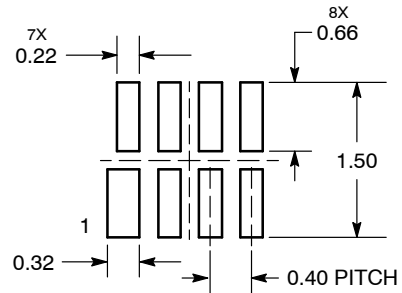


**NOTES:**

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 mm FROM TERMINAL TIP.
4. MOLD FLASH ALLOWED ON TERMINALS ALONG EDGE OF PACKAGE. FLASH MAY NOT EXCEED 0.03 ONTO BOTTOM SURFACE OF TERMINALS.
5. DETAIL A SHOWS OPTIONAL CONSTRUCTION FOR TERMINALS.

DIM	MILLIMETERS	
	MIN	MAX
A	0.45	0.55
A1	0.00	0.05
A3	0.127 REF	
b	0.15	0.25
b2	0.30 REF	
D	1.80 BSC	
E	1.20 BSC	
e	0.40 BSC	
L	0.45	0.55
L1	0.00	0.03
L2	0.40 REF	

### MOUNTING FOOTPRINT SOLDERMASK DEFINED



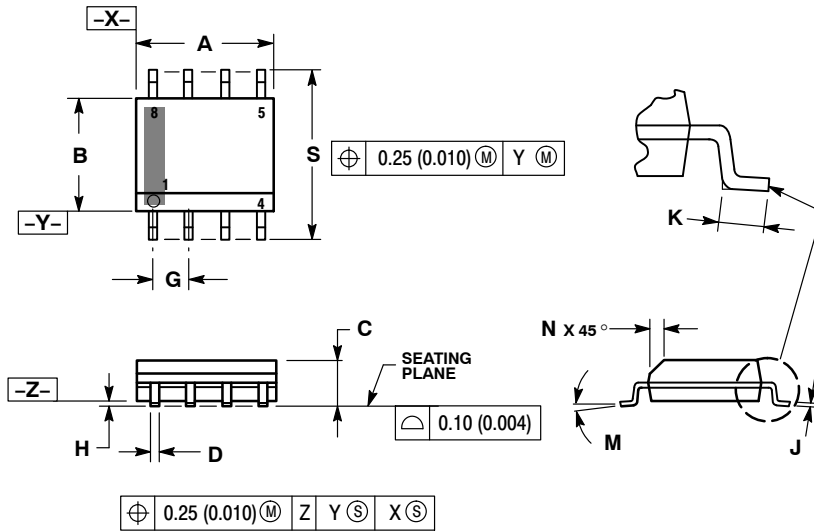
DIMENSIONS: MILLIMETERS



# NL3V2T244, NL3V2T240

## PACKAGE DIMENSIONS

SO-8  
CASE 751-07  
ISSUE AK

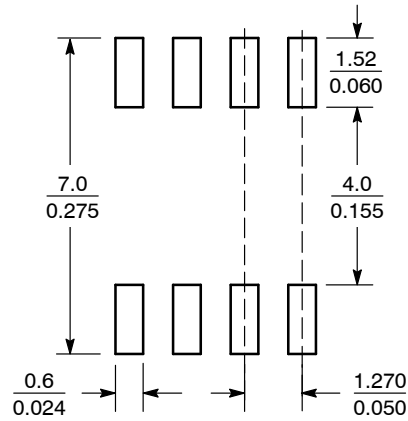


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.
6. 751-01 THRU 751-06 ARE OBSOLETE. NEW STANDARD IS 751-07.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.80	5.00	0.189	0.197
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.053	0.069
D	0.33	0.51	0.013	0.020
G	1.27 BSC		0.050 BSC	
H	0.10	0.25	0.004	0.010
J	0.19	0.25	0.007	0.010
K	0.40	1.27	0.016	0.050
M	0°	8°	0°	8°
N	0.25	0.50	0.010	0.020
S	5.80	6.20	0.228	0.244

### SOLDERING FOOTPRINT\*



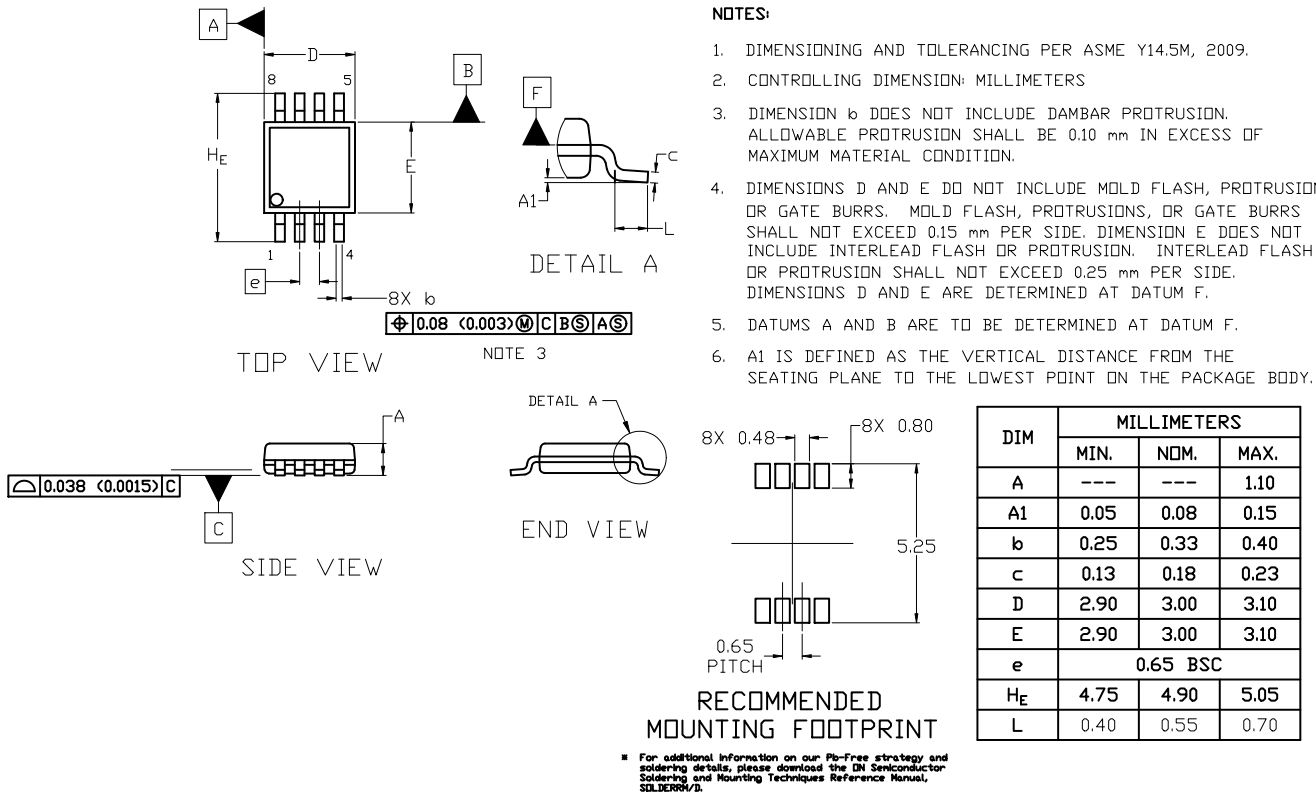
SCALE 6:1  $\left( \frac{\text{mm}}{\text{inches}} \right)$

\*For additional information on our Pb-Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

# NL3V2T244, NL3V2T240

## PACKAGE DIMENSIONS

Micro8  
CASE 846A-02  
ISSUE K



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